

40Gb/s QSFP+ Passive Copper Cable

40G-Q-DACx

■ Product Features

- ✓ Available in lengths of 1 to 5m
- ✓ 4 independent full-duplex channels up To 11.3Gbps data rate per wavelength
- ✓ Hot-pluggable QSFP+ footprint
- ✓ RoHS compliant and Lead Free
- ✓ Power dissipation <0.1W (0~70°C)
- ✓ Commercial operating temperature optional
- ✓ Compliant with IEEE802.3ba, SFF-436



■ Applications

- ✓ 40G Ethernet
- ✓ Infiniband 4X SDR DDR QDR
- ✓ 40G Telecom connections

■ Product Selection

Part Number	Lengths	Wire Size
40G-Q-DAC1	1m	AWG30
40G-Q-DAC2	2m	AWG30
40G-Q-DAC3	3m	AWG30
40G-Q-DAC5	5m	AWG26

*For availability of additional cable lengths, please contact Fiberend.

■ Regulatory Compliance

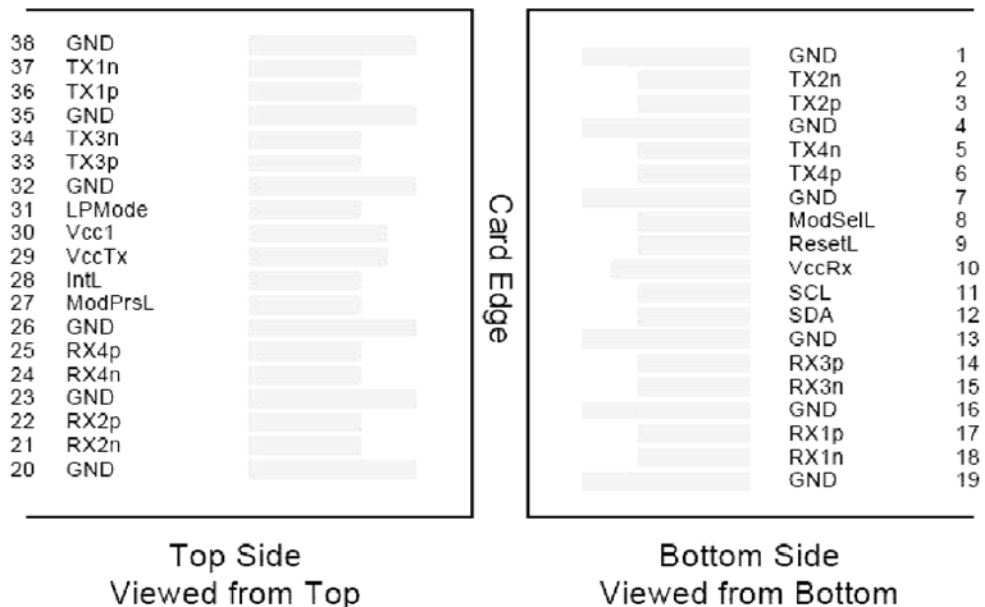
- ESD to the Electrical PINs: compatible with MIL-STD-883 Method3015
- Immunity compatible with IEC 61000-4-3
- EMI compatible with FCC Part 15 Class B EN55022 Class B (CISPR 22B) VCCI ClassB
- RoHS compliant with RoHS 2(2011/65/EU)

■ Pin Descriptions

Pin	Symbol	Name/Description
1	GND	Ground
2	Tx2n	Transmitter Inverted Data Input, CML-I
3	Tx2p	Transmitter Non-Inverted Data output, CML-I
4	GND	Ground

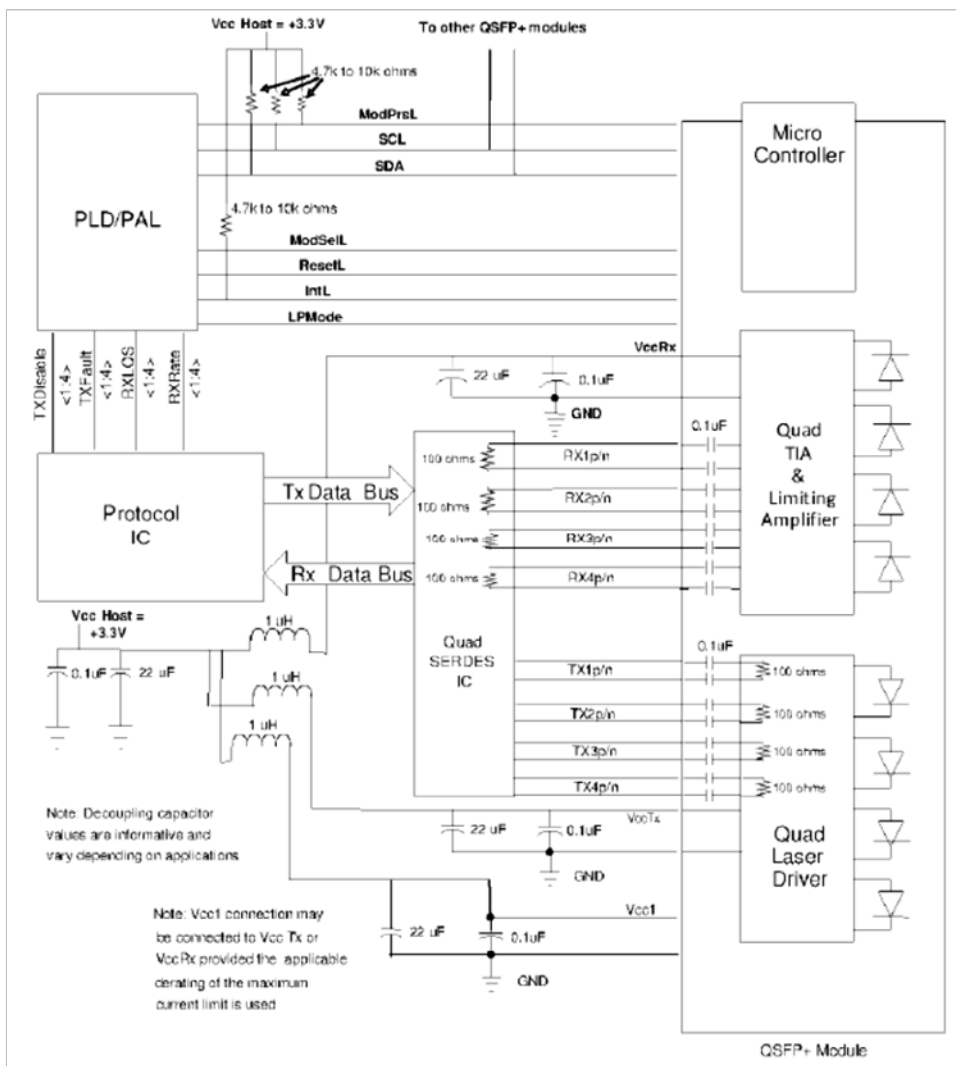
5	Tx4n	Transmitter Inverted Data Input, CML-I
6	Tx4p	Transmitter Non-Inverted Data output, CML-I
7	GND	GND
8	ModSelL	The ModSelL is an input pin. When held low by the host, the module responds to 2-wire serial communication commands. The ModSelL allows the use of multiple QSFP+ modules on a single 2-wire interface bus. When the ModSelL is “High”, the module shall not respond to or acknowledge any 2-wire interface communication from the host. ModSelL signal input node must be biased to the “High” state in the module
9	ResetL	The ResetL pin must be pulled to Vcc in the QSFP+ module. A low level on the ResetL pin for longer than the minimum pulse length (t_Reset_init) initiates a complete module reset, returning all user module settings to their default state. Module Reset Assert Time (t_init) starts on the rising edge after the low level on the ResetL pin is released.
10	VccRx	+ 3.3V Power Supply Receiver
11	SCL	2-Wire Serial Interface Clock
12	SDA	2-Wire Serial Interface Data
13	GND	GND
14	Rx3p	Receiver Non-Inverted Data Output, CML-O
15	Rx3n	Receiver Inverted Data Output, CML-O
16	GND	GND
17	Rx1p	Receiver Non-Inverted Data Output, CML-O
18	Rx1n	Receiver Inverted Data Output, CML-O
19	GND	Ground
20	GND	Ground
21	Rx2n	Receiver Inverted Data Output, CML-O
22	Rx2p	Receiver Non-Inverted Data Output, CML-O
23	GND	Ground
24	Rx4n	Receiver Inverted Data Output, CML-O
25	Rx4p	Receiver Non-Inverted Data Output, CML-O
26	GND	Ground
27	ModPrsL	Module Present, connect to GND

28	IntL	The IntL pin is an open collector output and must be pulled to host supply voltage on the host board. The INTL pin is de-asserted “High” after completion of reset, when byte 2 bit 0 (Data Not Ready) is read with a value of ‘0’ and the flag field is read.
29	VccTx	+3.3 V Power Supply transmitter
30	Vcc1	+3.3 V Power Supply
31	LPMODE	The LPMODE pin shall be pulled up to Vcc in the QSFP+ module. This function is affected by the LPMODE pin and the combination of the Power_over-ride and Power_set software control bits (Address A0h, byte 93 bits 0,1).
32	GND	Ground
33	Tx3p	Transmitter Non-Inverted Data Input, CML-I
34	Tx3n	Transmitter Inverted Data Output, CML-I
35	GND	Ground
36	Tx1p	Transmitter Non-Inverted Data Input, CML-I
37	Tx1n	Transmitter Inverted Data Output, CML-I
38	GND	Ground



Pin-out of Connector Block on Host Board

Recommend Circuit Schematic



Absolute Maximum Ratings

Parameter	Symbol	Min	Typ	Max	Unit	Ref.
Maximum Supply Voltage	Vcc	-0.5		+4.0	V	
Storage Temperature	TS	-40		+85	°C	
Operating Humidity	RH	0		85	%	

Recommended Operating Conditions

Parameter	Symbol	Min	Typ	Max	Unit	Ref.
Power Supply Voltage	Vcc	3.13	3.30	3.47	V	
Power Supply Current	Icc	-	-	0.03	A	Commercial
Case Operating Temperature	Tc	0	-	+70	°C	Commercial
Bit Rate Each Lane	Br	1	-	11.3	Gbps	

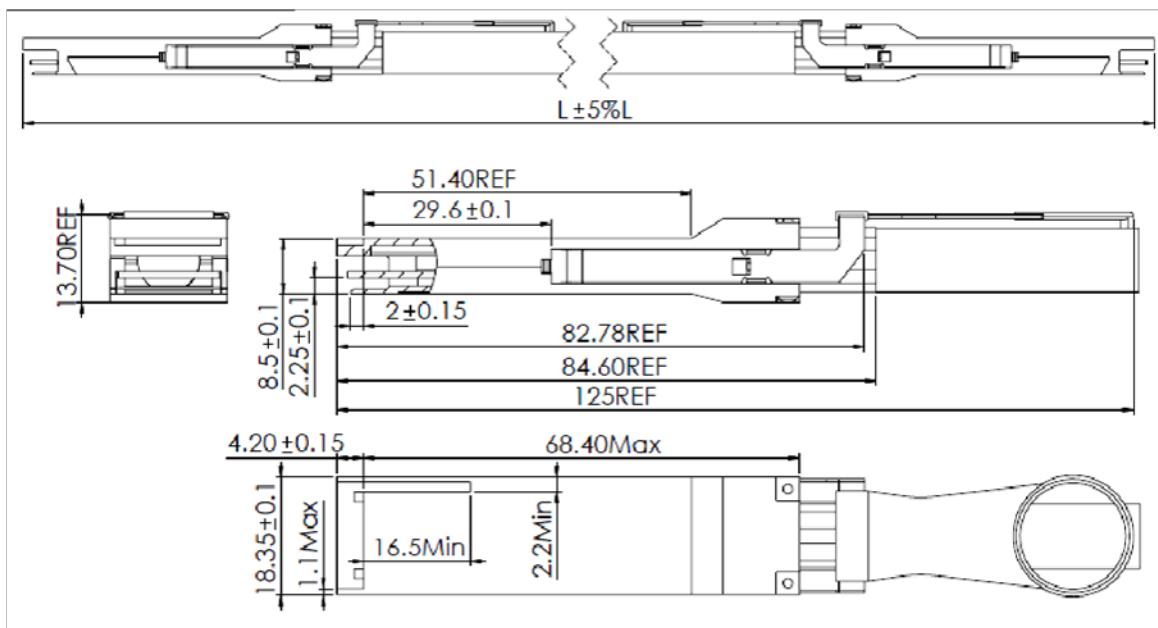
■ Electrical Characteristics (TOP=25°C, Vcc=3.3Volts)

Parameter	Symbol	Min	Typ	Max	Unit	Note
Transmitter						
Input differential impedance	Rin	80	100	120	Ω	
Receiver						
Output differential impedance	Rout	80	100	120	Ω	
S Parameters (10GSFP+Cu Cable Assembly Specifications at B' and C')						
Differential Output/Input Reflection Coefficient	SDDxx			$-12 + 2 \times \text{SQRT}(f)$	dB	1
				$-6.3 + 13 \times \log_{10}(f/5.5)$	dB	2
Common Mode Output/Input Reflection Coefficient	SCCxx			$-7 + 1.6 \times f$	dB	3
				-3	dB	4

Note:

- 1: 0.01-4.1 GHz, reference differential impedance is 100 Ω. The dB value listed here are the same as dBe.
- 2: 4.1-11.1 GHz, reference differential impedance is 100 Ω. The dB value listed here are the same as dBe.
- 3: 0.01-2.5 GHz, reference differential impedance is 25 Ω. The dB value listed here are the same as dBe.
- 3: 2.5-11.1 GHz, reference differential impedance is 25 Ω. The dB value listed here are the same as dBe.

■ Mechanical Specifications



40G-Q-DACx

Parameter	Symbol	Min	Typ	Max	Unit
Durability		100			cycle
Transceiver Insert Force		40			N
Transceiver Extraction Force		11.5			N
Transceiver Retention Force		90		170	N

■ EEPROM Information

EEPROM memory map specific data field description is as below:

